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| Project | **Specification of Sensor Interface for Cyber and Physical World**  <<https://sagroups.ieee.org/2888/> **>** |
| Title | External MOU with Inter-Reality Technology Forum |
| DCN | **2888-20-0055-00-0000** |
| Date Submitted | **December 24, 2020** |
| Source(s) | Sangkwon Jeong, [ceo@joyfun.kr](mailto:ceo@joyfun.kr) (Joyfun) |
| Re: |  |
| Abstract | This contribution is MOU letter within IEEE 2888 WG and Inter-Reality Technology Forum |
| Purpose | External MOU with Inter-Reality Technology Forum |
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**Request for Establishment of External MOU**   
**between the IEEE 2888 and Immersive Inter-Reality Technology Forum**

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| **Category** | External MOU with IEEE 2888 |
| **MOU Organization** | **Immersive Inter-Reality Technology Forum**  Web : None  **Contact person**: Mr Gookhwan Lee  Company: JoyFun Inc.,  Address: 609 Kolon Science Valley 2nd, 55, Digitalro 34 gil,  Gurogu, Seoul  08378, Republic of Korea  Email : ghlee@joyfun.kr |
| **MOU Representative**  **to Immersive Inter-Reality Technology Forum** | Name : Mr. Dongil Seo  Company: JoyFun Inc.  Email : dillon@joyfun.kr |
| **MOU Representative**  **from IEEE 2888** | Name : Prof. Kyoungro Yoon  Company: Konkuk Univ.  Email : yoonk@konkuk.ac.kr |
| **IEEE's Approval** | To be determined after IEEE internal discussion |
| **Statement of Expected Benefits and Responsibilities** | The MOU will bring an efficiency of communications between the two organizations and contribute to more valid and efficient standard development in terms of defining interfaces of sensors for synchronizing cyber and physical world. Both organizations can give valuable feedbacks to the corresponding organization after reviewing the draft document reflecting efforts of each standardization body. In addition, it is available for members of each group to participate in the standard meetings of the other group as MOUs, and to make more world-wide network.  We believe that there are mutual responsibilities to make collaboration between the two organizations. Each party takes a responsibility to follow the international rules specified in each standard organization. During the standardization, it is necessary to make sure the appropriate procedures for the official processing. |

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| *Dated:* |  | *Dated:* |
| 24-December 2020 |  | 24-December 2020 |
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| *Signature:* |  | *Signature:* |
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